SPACE, SATELLITE, & LAUNCH Advanced Composite Materials Selector Guide

WE'VE BEEN TO MARS. MORE THAN ONCE.



SPACE, SATELLITE, & LAUNCH

OUR OBJECTIVES

Connecting the Furthering Reducing planet scientific weight understanding

High reliability

SPACE FLIGHT HERITAGE

With more than 25 years of space flight heritage, Toray Advanced Composites is the undisputed leader in developing and manufacturing cutting-edge, high-reliability materials for the space market. Our products are found on most satellites, spacecraft, and planetary rovers launched from the Western world. No other materials company offers the pedigree, experience, or breadth of product knowledge to meet the demanding needs of the space, launch, and satellite industry.

In partnership with our customers and with a close eye to evolving market needs, we have developed a comprehensive product portfolio of industry-leading resin systems for use on high-modulus PAN and pitch carbon fiber and specialty fabrics, as well as standard reinforcements.

COMMERCIAL SATELLITES AND LAUNCH VEHICLES

We continue to develop and serve our long-standing customers, who are building ever larger telecommunications satellites to accommodate more powerful and sophisticated payloads - offering higher resolution, more deployable structures, and larger, more accurate reflectors.

Toray also offers a full range of products to meet the demands of today's heavy-lift commercial launch vehicles being utilized today to send high-value missions reliably into space.

SCIENCE AND EXPLORATION

Our next generation materials support science missions, going further than ever before to unlock the secrets of the universe. Tomorrow's spacecraft will journey to more aggressive,





Stephen Hawking

hotter, and colder environments, and with greater numbers of planetary rovers and landers. Toray's materials are also playing a key role in sending humans to Mars.

NFW SPACE

Today's rapidly emerging New Space market is bringing new opportunities to meet material demands for mass-produced satellite constellations, small launch-on-demand vehicles, and swarms of high-flying pseudo-satellite drones. New Space will bring internet connectivity, new science, and big data to billions more people.

For more product information such as product data sheets, case studies, or technical papers, please use the following resources:



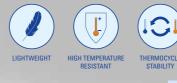
Search for the Toray TAC Product Selector App Store



www.toraytac.com/space Go to our online resource center for product data sheets and technical resources.

HEAT SINKS Composite plates and tubes are manufactured with Toray highly conductive pitch-based carbon fiber prepregs. These unique materials provide superior thermal conductivity to channel heat from electrical components. Toray prepreg systems for these applications are designed to withstand high temperatures while providing exceptional resistance to the effects of thermocycling.

REFLECTORS AND ANTENNAS Toray space flightapproved cyanate ester and epoxy systems utilize high-modulus carbon fiber and specialized weaves. These materials are designed to deliver low CTE on reflectors, antennas, and deployable structures over space temperature extremes.



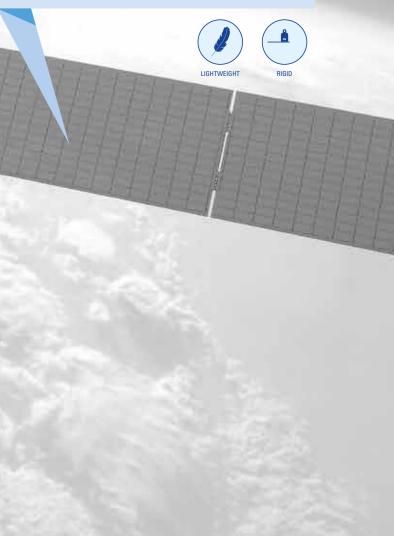
PRECISION STRUCTURES Toray materials protect the payload during launch and resist moisture to prevent outgassing in orbit. Toray high-modulus PAN or pitch-based carbon fiber prepregs are utilized for strength, stiffness, and light weight. Structures made from Toray products, including benches for optics and instrumentation, withstand extreme conditions in space, including thermal cycling, atomic oxygen, and radiation.





SOLAR ARRAY PANEL SUBSTRATES, BOOMS, AND

TRUSSES These satellite applications utilize Toray highmodulus carbon fibers with resins that provide low coefficients of thermal expansion (CTE), low coefficients of moisture expansion (CME), low outgassing, and radiation resistance.



LAUNCH VEHICLE Product Applications

SPACE, SATELLITE, & LAUNCH Product Overview

THERM	OSET PE	REPREGS EP	OXY CURE TIME AND TEMPERATURE	KEY PRO	DUCT CHARACTERISTICS	OUTGASSING, CTE/ CME OR HOT/WET DATA	00A/VB0	TOUGHENED	LOW MOSITURE Absorption	SPACE/ Satellite	LAUNCH
EX-1522	Modified Epoxy	180°C (356°F)	2 hours at 177°C (350°F)	Good betw epox	ellent mechanical properties d balance of properties veen cyanate ester and ky D _k and D _L	TML 0.28 % CVCM 0.01 % WVR 0.16 % TML-WVR 0.12 %	0	0	0	0	-
TC250	Ероху	140°C (285°F) or 180°C (356°F) with post cure	60 minutes at 88°C (190°F), followed by 2 hours at 130°C (265°F)	► Long abili	MP qualified g out life of 60 days and the ty to post cure makes it l for large structures	Wet T _g 125°C (257°F) Cured at 130°C (265°F) TML 0.27 % CVCM 0.01 % WVR 0.32 %	0	0			0
RS-36 / RS-36-1	Ероху	181°C (358°F) 190°C (374°F)	90 minutes at 177°C (350°F)	🕨 High	qualified for solar array toughness moisture absorption	TML 0.4 % CVCM 0.01 % WVR 0.17 % TML-WVR 0.12 %	0	0	0	0	
TC275-1	Ероху	164°C (327°F) or 183°C (362°F) with 177°C (350°F) post cure	6 hours at 135°C (275°F) Optional post cure of 2 hours at 177°C (350°F)	fabri Low Exce	l for large structure ication density ellent toughness for impact stance	Wet T _g 136°C (277°F) TML 0.44 % CVCM 0.01 % WVR 0.22 %	0	0	0	0	С
TC275- 1E NEW	Ероху	168°C (334°F)	6 hours at 135°C (275°F) Optional post cure of 2 hours at 177°C (350°F	► Allov large	g out time version of TC275-1 ws construction of thick or er composites structures /VBO processable		0	0	0	0	С
TC350-1	Ероху	191°C (376°F)	2 hours at 177°C (350°F)		/VBO processable d hot/wet properties	Wet T _g 160°C (320°F) TML 0.55 % CVCM 0.01 % WVR 0.27 %	0	0	0		0
TC380 NEW	Ероху	204°C (399°F)	2 hours at 177°C (350°F)	strue appl ► Exce	eme toughness for ctural and cryogenic ications ellent balance of CAI, OHC, hot/wet properties	TML 0.83 % CVCM 0.01 % WVR 0.75 %	0	0	0		0
THERM	OSET PI	REPREGS BN	/1					-	URE N		
	RESIN MATRIX	DRY Tg ONSET	CURE TIME A TEMPERATU		KEY PRODUCT CHARACTERISTICS		00A/VB0	TOUGHENED	LOW MOSITURE ABSORPTION	SPACE/ Satellite	LAUNCH
RS-8HT	BMI	203°C (397°F) or 285°C (545°F) with post cure	2 hours at 2 (400°F) follo by 6 hours 250°C (482	wed at	 Excellent elevated tempe performance Good moisture resistance 				0		0

THERM	RESIN	REPREGS EP	CURE TIME AND	KEY PRO	DDUCT CHARACTERISTICS	OUTGASSING, CTE/ CME OR HOT/WET	00A/VB0	TOUGHENED	LOW MOSITURE Absorption	SPACE/ Satellite	LAUNCH
EX-1522	MATRIX Modified Epoxy	180°C (356°F)	2 hours at 177°C (350°F)	 Exc Goo betw epo 	ellent mechanical properties d balance of properties veen cyanate ester and	DATA TML 0.28 % CVCM 0.01 % WVR 0.16 % TML-WVR 0.12 %	00	0		0 SAT	LAL
TC250	Ероху	140°C (285°F) or 180°C (356°F) with post cure	60 minutes at 88°C (190°F), followed by 2 hours at 130°C (265°F)	► Lon abili	AMP qualified g out life of 60 days and the ity to post cure makes it Il for large structures	Wet T _g 125°C (257°F) Cured at 130°C (265°F) TML 0.27 % CVCM 0.01 % WVR 0.32 %	0	0			С
RS-36 / RS-36-1	Ероху	181°C (358°F) 190°C (374°F)	90 minutes at 177°C (350°F)	🕨 Higł	qualified for solar array n toughness n moisture absorption	TML 0.4 % CVCM 0.01 % WVR 0.17 % TML-WVR 0.12 %	0	0	0	0	
TC275-1	Ероху	164°C (327°F) or 183°C (362°F) with 177°C (350°F) post cure	6 hours at 135°C (275°F) Optional post cure of 2 hours at 177°C (350°F)	fabr Low Exc	al for large structure ication r density ellent toughness for impact stance	Wet T _g 136°C (277°F) TML 0.44 % CVCM 0.01 % WVR 0.22 %	0	0	0	0	0
TC275- 1E NEW	Ероху	168°C (334°F)	6 hours at 135°C (275°F) Optional post cure of 2 hours at 177°C (350°F	Allo larg	g out time version of TC275-1 ws construction of thick or er composites structures AVBO processable		0	0	0	0	С
TC350-1	Ероху	191°C (376°F)	2 hours at 177°C (350°F)		A/VBO processable d hot/wet properties	Wet T _g 160°C (320°F) TML 0.55 % CVCM 0.01 % WVR 0.27 %	0	0	0		0
TC380 NEW	Ероху	204°C (399°F)	2 hours at 177°C (350°F)	stru app ► Exc	eme toughness for ctural and cryogenic lications ellent balance of CAI, OHC, hot/wet properties	TML 0.83 % CVCM 0.01 % WVR 0.75 %	0	0	0		0
THERM	OSET PI	REPREGS BN	ЛІ						3		
	RESIN MATRIX	DRY T _g ONSET	CURE TIME A TEMPERATU		KEY PRODUCT CHARACTERISTICS		00A/VB0	TOUGHENED	LOW MOSITURE ABSORPTION	SPACE/ Satellite	LAUNCH
RS-8HT	BMI	203°C (397°F) or 285°C (545°F) with post cure	2 hours at 2 (400°F) follo by 6 hours 250°C (482	04°C wed at	 Excellent elevated temper performance Good moisture resistance 		0		0	0 0	0

BARREL FUSELAGE ASSEMBLIES, PAYLOAD SHROUDS, AND FAIRINGS

The latest generation of launch vehicles utilize Toray out-ofautoclave (OOA) processable prepreg systems for costcompetitive vehicle barrel assemblies, inner and outer stages, payload shrouds, and fairings for weight and cost savings.



CRYOTANKS Launch vehicle cryotanks utilize Toray toughened epoxies to provide high strength, low weight tanks.

MICROCRACK

LIGHTWEIG

STRUTS AND TUBES Toray exceptionally durable and microcrack-resistant thermosets deliver a lightweight, highstrength structure for landing leg assemblies, secondary tubes, and struts and conduits.

HIGH TEMPERATU RESISTANT

HEATSHIELDS Toray high-temperature cyanate ester prepregs create lightweight, thermally stable structures.

LIGHTWEIGHT

HIGH TEMPERATURE RESISTANT

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THERMOCYCLE STABILITY



SPACE, SATELLITE, & LAUNCH Product Overview

THERMOSET PREPREGS CYANATE ESTER

THERMO	OSET PR	EPREGS CY/	ANATE ESTER	3			Ð	ITURE ION		
	RESIN MATRIX	DRY T _g onset	CURE TIME AND TEMPERATURE	KEY PRODUCT CHARACTERISTICS	OUTGASSING, CTE/ CME OR HOT/WET DATA	00A/VB0	TOUGHENED	LOW MOSITURE Absorption	SPACE/ SATELLITE	LAUNCH
EX-1515	Cyanate Ester	121°C (249°F) or 174°C (345°F) with post cure	3 hours at 121°C (250°F) Optional post cure of 2 hours at 177°C (350°F)	 Low density Resistant to microcracking Low residual stress with 121°C (250°F) cure 	TML 0.18 % CVCM 0.01 % CTE 61 ppm/°C		0	0	0	
TC410	Cyanate Ester	112°C (234°F) or 181°C (358°F) with post cure	3 hours at 121°C (250°F) Optional post cure at 177°C (350°F)	 Low CTE 58.4 µm/m/°C Extremely low CME 1205 µm/m/% Ideal system for stable structures 	TML 0.29 % CVCM < 0.01 % WVR 0.17 % TML-WVR 0.12 %		0	0	0	
BTCy-1A	Cyanate Ester	185°C (365°F) or 207°C (405°F) with post cure	2 hours at 177°C (350°F) Optional post cure of 60 minutes at 204°C (400°F)	► Tough ► High T _g	CTE 77 ppm/°C		0	0	0	
RS-3/ RS-3C	Cyanate Ester	191°C (375°F) or 254°C (490°F) with post cure	2 hours at 177°C (350°F) Optional post cure of 60 minutes at 232°C(450°F)	 Extensive qualification portfolio Low CTE, CME High stability RS-3C is controlled-flow version 	TML 0.22 % CVCM 0.01 %	0	0	0	0	
TC420	Cyanate Ester	176°C (349°F) or 348°C (658°F) with post cure	3 hours at 177°C (350°F) Optional post cure at 260°C (500°F)	 Good resistance to microcracking Capable of high-temperature service Ideal for heat shield and ablative applications 	TML 0.41 % CVCM < 0.01% WVR 0.28% CTE 55 ppm/°C	0	0	0	0	0

RTM RESINS

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	RESIN	DRY T _g ONSET	CURE TIME AND TEMPERATURE	KEY PRODUCT CHARACTERISTICS	00A/VB0	TOUGHENE	LOW MO Absorp ⁻	SPACE/ SATELLIT	LAUNCH
EX-154	5 Cyanate Ester	173°C (345°F)	2 hours at 177°C (350°F)	 Toughened resin system with low viscosity of 140 cPs at 43°C (110°F) Long pot life for complex parts 				0	
RS-16	Cyanate Ester	151°C (304°F) 252°C (486°F) with elevated post cure	2 hours at 135°C (275°F)	 Low-temperature cure resin system Post curable for higher T_g 				0	
EX-151) Cyanate Ester	193°C (380°F)	2 hours at 177°C (350°F)	 Low room temperature viscosity of 150 cPs Post curable for higher Tg 			0		

TORAY	TORAY MICROPLY™ FILM ADHESIVES EPOXY						MOSITURE Orption	E	
	RESIN MATRIX	DRY T _g ONSET	CURE TIME AND TEMPERATURE	KEY PRODUCT CHARACTERISTICS	00A/VB0	TOUGHENED	LOW MO Absorp [.]	SPACE/ Satelli	LAUNCH
RS-15H	Ероху	99°C (211°F)	6 hours at 93°C (200°F) Alternate cures are available	Low-temperature curing adhesive	0	0		0	
TC263	Ероху	110°C (230°F)	2 hours at 121°C (250°F)	 High peel strength Ideal for metal or composite bonding 	0	0		0	0
TC310	Ероху	157°C (315°F)	2 hours at 177°C (350°F)	Ideal composite bonding film adhesive	0	0		0	0

TORAY	TORAY MICROPLY™ FILM ADHESIVES CYANATE ESTER						SITURE TION	ų	
	RESIN MATRIX	DRY Tg ONSET	CURE TIME AND TEMPERATURE	KEY PRODUCT CHARACTERISTICS	00A/VB0	TOUGHENED	LOW MOSITURE Absorption	SPACE/ Satelut	LAUNCH
EX-1516	Cyanate Ester	126°C (258°F)	5 hours at 121°C (250°F)	Compatible with Toray EX-1515 prepreg		0	0	0	
RS-4A	Cyanate Ester	195°C (383°F) or 238°C (460°F) with post cure	2 hours at 177°C (350°F) Optional post cure of 1.5-2 hours at 232°C (450°F)	Moisture resistant		0	0	0	
EX-1543	Cyanate Ester	191°C (376°F) or 211°C (412°F) with post cure	2 hours at 177°C (350°F) Optional post cure of 2 hours at 204°C (400°F)	 Compatible with 177°C (350°F) curing cyanate ester prepregs Low shrinkage Low outgassing 			0	0	
TC4015	Cyanate Ester	176°C (349°F) or 321°C (610°F) with post cure	2 hours at 177°C (350°F) Optional post cure of > 60 minutes at 232°C (450°F)	 Excellent high-temperature properties Compatible with TC420 	0		0	0	0

TORAY N	(240°F) 121°C (250°F) ► 0.64 g/cc (40 pcf) density ► T _g estimated from base resin data			NED	ISI TURE	ш			
		DRY T _g onset		KEY PRODUCT CHARACTERISTICS	00A/VB0	TOUGHENED	LOW MO Absorp	SPACE/ Satelli	LAUNCH
EM-3	Ероху			0.64 g/cc (40 pcf) density				0	
TCF4035	Ероху	140°C (284°F)	3 hours at 130°C (265°F)	 Low density 0.64 g/cc (40 pcf) Compatible with TC250, may be post cured for higher Tg 	0	0			0

SPACE, SATELLITE, & LAUNCH Product Overview

TORAY MICROPLY™ SYNTACTICS CYANATE ESTER RESIN CURE TIME AND

	MATRIX	DRY T _g ONSET	TEMPERATURE	KEY PRODUCT CHARACTERISTICS	00A	TOU	LOW	SPA	LAU
TCF4001	Cyanate Ester	176°C (349°F)	2 hours at 177°C (350°F) Optional post cure of 60-90 minutes at 232°C (450°F)	Low density 0.38 g/cc (24 pcf)	0			0	
TCF4050	Cyanate Ester	176°C (349°F) or 232°C (450°F) with post cure	2 hours at 177°C (350°F) Optional post cure of 60-90 minutes at 232°C (450°F)	 Expanding syntactic film/core splice Density of 0.28-0.55 g/cc (17-35 pcf) Compatible with TC420 prepreg system 	0	0		0	
EM-5A	Cyanate Ester	204°C (400°F)	2 hours at 177°C (350°F) Optional post cure of 60-90 minutes at 232°C (450°F)	Expansion ratio of 4 x	0			0	

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TORAY MICROPLY™ SYNTACTICS OTHER THERMOSET MATRICES

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	RESIN MATRIX	DRY T _g ONSET	CURE TIME AND TEMPERATURE	KEY PRODUCT CHARACTERISTICS	00A/VB0	TOUGHE	LOW MO ABSORP	SPACE/ SATELLI1	LAUNCH
SF-4	BMI	295°C (563°F)	2 hours at 204°C (400°F), then 6 hour post cure at 250°C (452°F)	 Low density 0.62 g/cc (39 pcf) Compatible with RS-8HT and other BMI systems 	0			0	

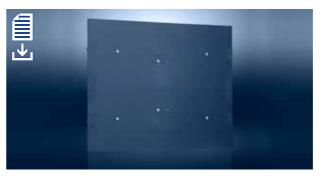
BMC THERMOSET EPOXY

						NED	LIS DE	벁	
	RESIN MATRIX	DRY T _g ONSET	CURE TIME AND TEMPERATURE	KEY PRODUCT CHARACTERISTICS	00A/VB0	TOUGHENED	LOW MOSITU Absorption	SPACE/ SATELLITE	LAUNCH
MS-1A	Ероху	164°C (327°F)	15-30 minutes at 138°C (280°F) followed by post cure of 1-2 hours at 177°C (350°F)	 Chopped fiber epoxy BMC with high-modulus fiber 				0	0
MS-1H	Ероху	191°C (375°F)	15-30 minutes at 138°C (280°F) followed by post cure of 1-2 hours at 177°C (350°F)	 Chopped fiber epoxy BMC with intermediate-modulus fiber 				0	
MS-4H	Ероху	191°C (375°F)	15-30 minutes at 138°C (280°F) followed by post cure of 1-2 hours at 177°C (350°F)	 Chopped fiber epoxy BMC with high- strength (standard-modulus) fiber 				0	0

TORAY	TORAY CETEX* BMC THERMOPLASTIC						SITURE	2	
	RESIN MATRIX	DRY T _g ONSET	PROCESSING TEMPERATURE	KEY PRODUCT CHARACTERISTICS	00A/VB0	DURABII	LOW MO Absorp	SPACE/ SATELLI	LAUNCH
MC1100	PPS	90°C(194°F)	330°C (626°F)	 PPS based BMC Fire retardant 		0	0	0	0
MC1200	PEEK	143°C (290°F)	385°C(725°F)	 PEEK based BMC Fire retardant 		0	0	0	0

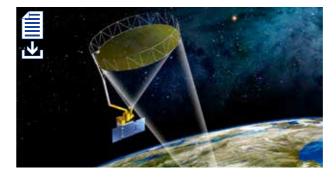
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For more product information such as product data sheets, case studies, or technical papers, please use the following resources:



Search for the Toray TAC Product Selector

- Learn about Airborne's Advanced Solar Array designed by Airbus Defence and Space for use in future ESA missions
- **Solar Arrays for Next Generation Satellites** Featured products: > Toray RS-36

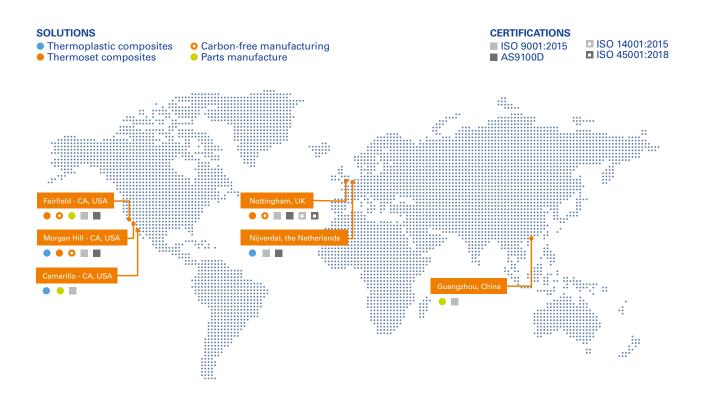
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- Learn about Northrop Grumman's deployable reflection dish, used in this NASA launch at **www.toray**tac.com/company/ news/2015
- Deployable Space Structure for SMAP Made Using Toray **Cetex**[•] (published in Composites World)



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LOCATIONS AND CAPABILITIES



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